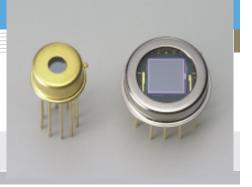


Si photodiode with preamp \$8745, \$8746

Photodiode and preamp integrated with feedback resistance and capacitance



S8745, S8746 are low-noise light sensors consisting of a large area Si photodiode, op amp, and feedback resistance and capacitance, all integrated into a small package. By simply connecting to a power supply, S8745 and S8746 can be used in low-light-level measurement such as spectrophotometry.

Features

- Si photodiode for UV to near IR precision photometry
- Small package with quartz window S8745: TO-5 S8746: TO-8
- FET input operational amplifier with low power dissipation
- Built-in Rf=1 G Ω and Cf=5 pF
- Variable gain with an externally connected resistor
- Low noise and NEP
- Guard ring structure for low level signal

Applications

- Spectrophotometry
- General-purpose optical measurement

■ General ratings / Absolute maximum ratings

	Dimensional outline/ Window material *	Active area size	Package	Number of terminals	Absolute maximum ratings					
Type No.					Vcc	(photodiode) VR	P	Topr	Storage temperature Tstg	
		(mm)			(V)	(V)	(mW)	(°C)	(°C)	
S8745	①/Q	2.4 × 2.4	TO-5	10	±20	5	500	-20 to +60	-30 to +80	
S8746	②/Q	5.8 × 5.8	TO-8	12	120	5	500	-20 10 +00	-30 10 +60	

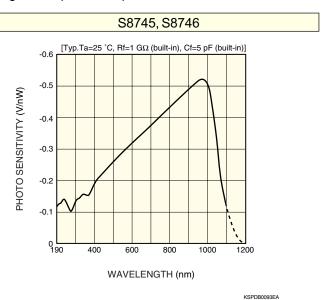
■ Electrical and optical characteristics (Typ. Ta=25 °C, Vcc=±15 V, RL=1 MΩ, unless otherwise noted)

Type No.	Spectral response range	Peak sensitivity wavelength λp		Feedback capacitance Cf (built-in)	Photo sensitivity S (V/nW)		Output noise voltage Vn Dark state f=10 Hz	equiv pov NE λ=	wer EP λρ	Output offset voltage Vos Dark state	Cut-off frequency fc	Supply current Icc Dark state
	(nm)	(nm)	$(G\Omega)$	(pF)	λ=200 nm	λ=λρ	(µVrms/Hz ^{1/2})	f=10 Hz	f=20 Hz	(mV)	(Hz)	(mA)
S8745	190 to	960	1	5	0.12	-0.52	6	11	11	±4	32	0.3
S8746	1100	900	'	3	-0.12	-0.52	7	15	15	<u> </u>	32	0.3

^{*} Window material Q: quartz glass

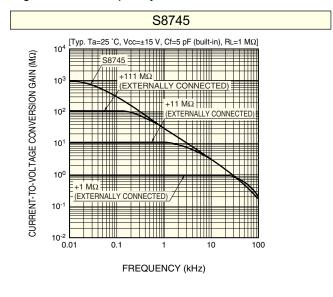


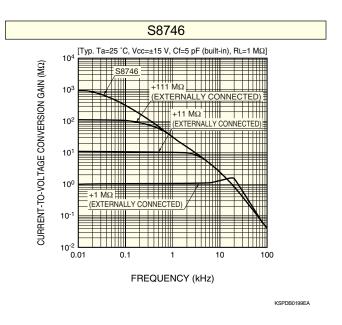
Figure 1 Spectral response



The built-in feedback resistance and capacitance of S8745 and S8746 are 1 G Ω and 5 pF, respectively. This combination provides a sensitivity of about -0.1 to -0.5 V/nW in the wavelength range of 190 to 1100 nm.

Figure 2 Gain-frequency characteristics





The current-to-voltage conversion gain can be varied by connecting an external feedback resistor between pins 4 and 6 for S8745, and between pins 9 and 12 for S8746 (see figure 5). Figure 2 shows the frequency response characteristics of S8745 and S8746 with or without an externally connected feedback resistor. Because S8745 and S8746 have a built-in resistor of 1 G Ω , for example the total feedback resistance will be converted to 100 M Ω by externally connecting a resistor of 111 M Ω . Choose the desired constant according to the incident light level to be detected.

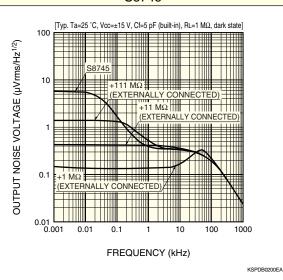
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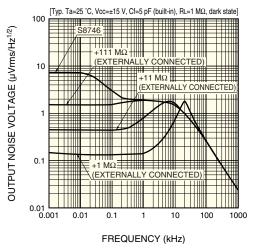
Note) If the external feedback resistor is 1 $M\Omega$ or less, gain peaking may occur in the frequency response. Therefore, be sure to connect a matched feedback capacitor for phase compensation.

Figure 3 Output noise voltage vs. frequency



S8746





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Output noise voltage and NEP (noise equivalent power) characteristics allow you to check whether the device can detect the low-level light you want to measure. Since NEP is given by the equation (1) as shown at the right, NEP at wavelengths other than λp can be easily calculated from Figure 1 and Figures 4.

Note) When S8745 and S8746 are used only with the internal current-to-voltage gain, it is recommended that the "-IN" lead (pin 6 for S8745; pin 9 for S8746) be cut off to a short length in order to reduce the influence of external noise as much as possible.

$$NEP (f, \lambda) = \frac{Vn (f)}{G_{I} - V (f) \cdot Ssi (\lambda)} = \frac{NEP (f, \lambda p) \cdot S (\lambda p)}{S (\lambda)} \cdots (1)$$

NEP (f, λ): NEP at frequency and wavelength to be detected

NEP (f, λp): NEP at peak wavelength (See Figures 4)

G_{I-V(f)}: Current-to-voltage conversion gain (See Figure 2)

Ssi (λ) : Sensitivity of Si photodiode

S (λ) : Sensitivity of S8745 and S8746 (See Figure 1.)

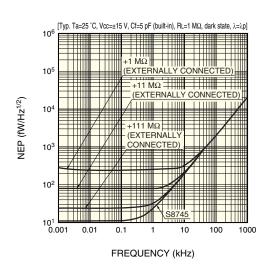
S (λp) : Sensitivity of S8745 and S8746 at peak wavelength, 0.5 V/nW

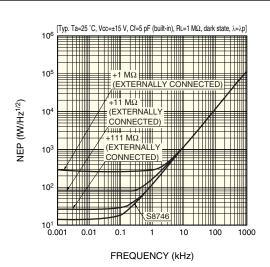
Vn (f) : Output noise voltage (See Figure 3)

Figure 4 NEP vs. frequency

S8745

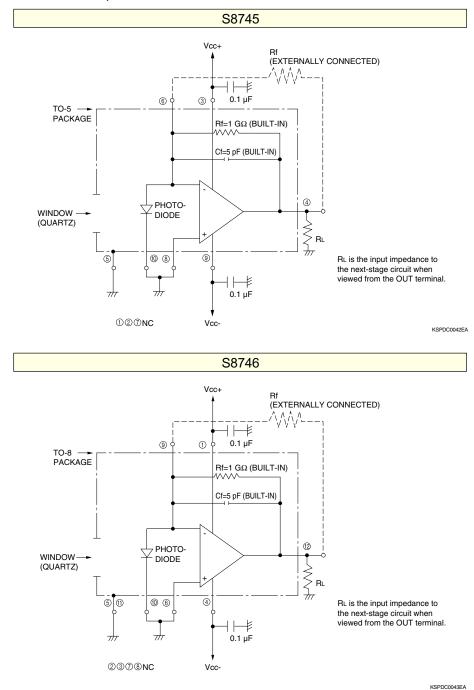






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Figure 5 External connection example



S8745 and S8746 use a package with the guard ring effect provided. To make it effective during measurement, the package leads (pin 5 for S8745; pins 5 and 11 for S8746) should be connected to the ground line.

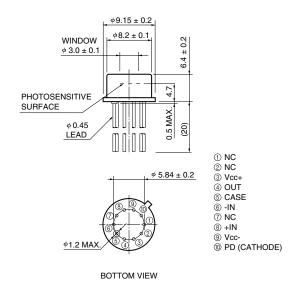
When a feedback resistor is externally connected, it is necessary to provide a guard ring on the circuit board or to provide a teflon standoff for the leads.

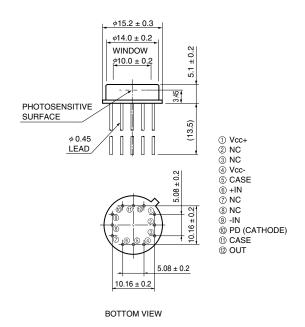
Note) A tantalum or ceramic capacitor of 0.1 to 10 μ F must be connected to the supply voltage leads (pins 3 and 9 for S8745; pins 1 and 4 for S8746) as a bypass capacitor used to prevent the device from oscillation.

Figure 6 Dimensional outlines (unit: mm)

① S8745

2 S8746





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Precautions for Use

S8745 and S8746 may be damaged or their performance may deteriorate by such factors as electro static discharge from the human body, surge voltages from measurement equipment, leakage voltages from soldering irons and packing materials. As a countermeasure against electro static discharge, the device, operator, work place and measuring jigs must all be set at the same potential. The following precautions must be observed during use:

- To protect the device from electro static discharge which accumulate on the operator or the operator's clothes, use a wrist strap or similar tools to ground the operator's body via a high impedance resistor (1 $M\Omega$).
- ullet A semiconductive sheet (1 M Ω to 100 M Ω) should be laid on both the work table and the floor in the work area.
- When soldering, use an electrically grounded soldering iron with an isolation resistance of more than 10 MΩ.
- For containers and packing, use of a conductive material or aluminum foil is effective. When using an antistatic material, use one with a resistance of 0.1 $M\Omega/cm^2$ to 1 $G\Omega/cm^2$

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